

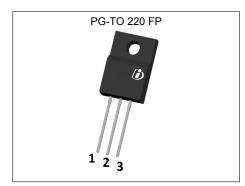
### MOSFET

#### 700V CoolMOS™ P7 Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

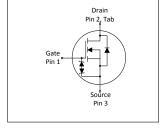
The latest CoolMOS™ P7 is an optimized platform tailored to target cost sensitive applications in consumer markets such as charger, adapter, lighting, TV, etc.

The new series provides all the benefits of a fast switching Superjunction MOSFET, combined with an excellent price/performance ratio and state of the art ease-of-use level. The technology meets highest efficiency standards and supports high power density, enabling customers going towards very slim designs.



#### **Features**

- Extremely low losses due to very low FOM R<sub>DS(on)</sub>\*Q<sub>q</sub> and R<sub>DS(on)</sub>\*E<sub>oss</sub>
- Excellent thermal behavior
- Integrated ESD protection diode
- Low switching losses (E<sub>oss</sub>)
- Product validation acc. JEDEC Standard



#### **Benefits**

- · Cost competitive technology
- Lower temperature
- High ESD ruggedness
- Enables efficiency gains at higher switching frequencies
- Enables high power density designs and small form factors







#### Potential applications

Recommended for Flyback topologies for example used in Chargers, Adapters, Lighting Applications, etc.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or seperate totem poles is generally recommended.

**Table 1** Key Performance Parameters

Parameter	Value	Unit	
V <sub>DS</sub> @ T <sub>j=25°C</sub>	700	V	
R <sub>DS(on),max</sub>	0.45	Ω	
$Q_{g,typ}$	13.1	nC	
I <sub>D,pulse</sub>	26	A	
E <sub>oss</sub> @ 400V	1.4	μJ	
$V_{(GS)th,typ}$	3	V	
ESD class (HBM)	2		

Type / Ordering Code	Package	Marking	Related Links
IPAN70R450P7S	PG-TO 220 FullPAK - Narrow Lead	70S450P7	see Appendix A



## **Table of Contents**

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1 Maximum ratings at  $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Oh a l	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	10.0 6.5	А	T <sub>C</sub> = 20°C T <sub>C</sub> = 100°C
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	25.9	Α	T <sub>C</sub> =25°C
Application (Flyback) relevant avalanche current, single pulse <sup>3)</sup>	I <sub>AS</sub>	-	-	3.5	А	measured with standard leakage inductance of transformer of 7μH
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	V <sub>DS</sub> =0400V
Gate source voltage	V <sub>GS</sub>	-16 -30	-	16 30	V	static; AC (f>1 Hz)
Power dissipation	P <sub>tot</sub>	-	-	22.7	W	T <sub>C</sub> =25°C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-40	-	150	°C	-
Continuous diode forward current	I <sub>S</sub>	-	-	4.7	Α	<i>T</i> <sub>C</sub> =25°C
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	-	-	25.9	Α	T <sub>C</sub> = 25°C
Reverse diode dv/dt <sup>4)</sup>	dv/dt	-	-	1	V/ns	V <sub>DS</sub> =0400V, I <sub>SD</sub> <=I <sub>S</sub> , T <sub>j</sub> =25°C
Maximum diode commutation speed <sup>4)</sup>	di <sub>f</sub> /dt	-	-	50	A/μs	V <sub>DS</sub> =0400V, I <sub>SD</sub> <=I <sub>S</sub> , T <sub>j</sub> =25°C
Insulation withstand voltage	V <sub>ISO</sub>	-	-	2500	V	V <sub>rms</sub> , T <sub>C</sub> =25°C, t=1min

#### 2 Thermal characteristics

Table 3 **Thermal characteristics** 

Doromotor	Cumbal	Values			11:4:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction	R <sub>thJC</sub>	-	-	5.5	°C/W	-
Thermal resistance, junction - ambient		-	-	80	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R <sub>thJA</sub>	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T <sub>sold</sub>	-	-	260	°C	1.6 mm (0.063 in.) from case for 10s

 $<sup>^{1)}</sup>$  DPAK / IPAK equivalent. Limited by  $T_{j\,max}.$   $T_{j}$  = 20°C. Maximum duty cycle D=0.5  $^{2)}$  Pulse width  $t_{p}$  limited by  $T_{j,max}$   $^{3)}$  Proven during verification test. For explanation please read AN - CoolMOS  $^{TM}$  700V P7.  $^{4)}$   $V_{DClink}$ =400V;  $V_{DS,peak}$ <br/> $< V_{CBR,DSS}$ ; identical low side and high side switch with identical  $R_{G}$ 



### 3 Electrical characteristics

**Table 4** Static characteristics

Davamatan	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	700	-	-	V	$V_{GS}$ =0V, $I_D$ =1mA
Gate threshold voltage	$V_{(\mathrm{GS})\mathrm{th}}$	2.50	3	3.50	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.12{\rm mA}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	- 10	1	μΑ	V <sub>DS</sub> =700V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C V <sub>DS</sub> =700V, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C
Gate-source leakage current incl. Zener diode	I <sub>GSS</sub>	-	-	1	μΑ	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.37 0.84	0.45 -	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =2.3A, T <sub>j</sub> =25°C V <sub>GS</sub> =10V, I <sub>D</sub> =2.3A, T <sub>j</sub> =150°C
Gate resistance	<b>R</b> <sub>G</sub>	-	10	-	Ω	f=1 MHz, open drain

**Table 5** Dynamic characteristics

Parameter	Comple		Value	s	Unit	Nata (Tant Oan dition
	Symbol	Min.	Тур.	Max.		Note / Test Condition
Input capacitance	Ciss	-	424	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz
Output capacitance	Coss	-	8	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz
Effective output capacitance, energy related <sup>1)</sup>	C <sub>o(er)</sub>	-	21	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V
Effective output capacitance, time related <sup>2)</sup>	C <sub>o(tr)</sub>	-	251	-	pF	I <sub>D</sub> =constant, V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V
Turn-on delay time	t <sub>d(on)</sub>	-	16	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =1.7A, $R_{\rm G}$ =5.3 $\Omega$
Rise time	t <sub>r</sub>	-	6.5	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =1.7A, $R_{\rm G}$ =5.3 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	70	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =1.7A, $R_{\rm G}$ =5.3 $\Omega$
Fall time	t <sub>f</sub>	-	20	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =1.7A, $R_{\rm G}$ =5.3 $\Omega$

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Gate to source charge	$Q_{\rm gs}$	-	1.9	-	nC	$V_{DD}$ =400V, $I_{D}$ =1.7A, $V_{GS}$ =0 to 10V
Gate to drain charge	$Q_{gd}$	-	5.0	-	nC	$V_{DD}$ =400V, $I_{D}$ =1.7A, $V_{GS}$ =0 to 10V
Gate charge total	<b>Q</b> g	-	13.1	-	nC	$V_{DD}$ =400V, $I_{D}$ =1.7A, $V_{GS}$ =0 to 10V
Gate plateau voltage	V <sub>plateau</sub>	-	4.4	-	V	$V_{DD}$ =400V, $I_{D}$ =1.7A, $V_{GS}$ =0 to 10V

 $<sup>^{1)}</sup>$   $C_{\text{o(er)}}$  is a fixed capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 400V  $^{2)}$   $C_{\text{o(tr)}}$  is a fixed capacitance that gives the same charging time as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 400V

## 700V CoolMOS™ P7 Power Transistor



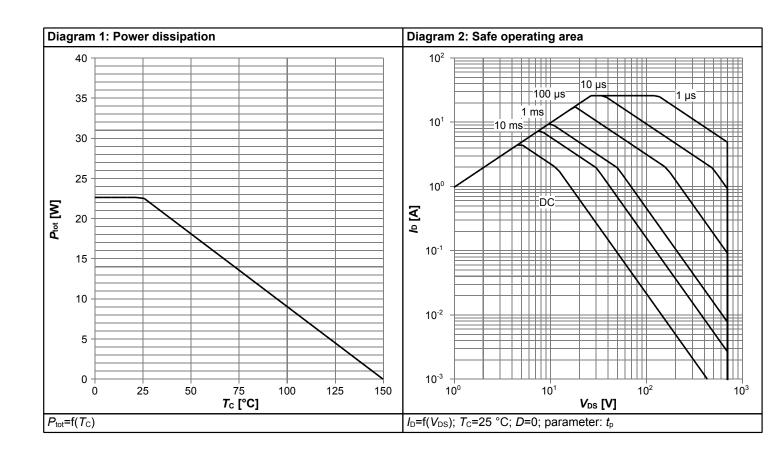


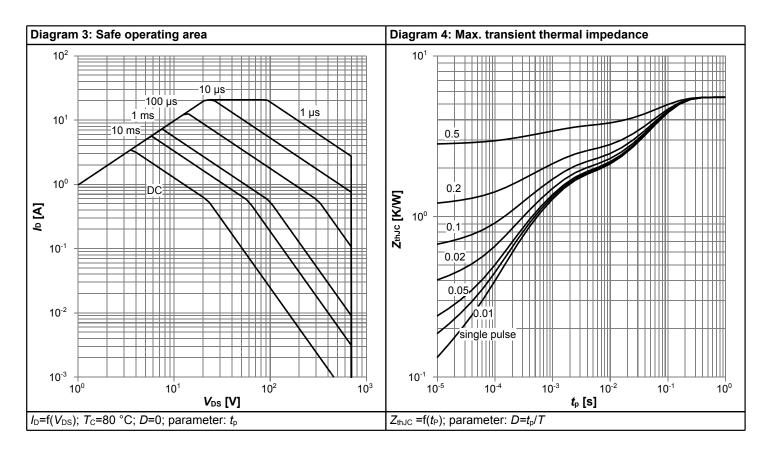
### Table 7 Reverse diode characteristics

Parameter	Cymbal	Values			Linit	Nata / Tant Camalities
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.9	-	V	$V_{GS}$ =0V, $I_F$ =2.6A, $T_j$ =25°C
Reverse recovery time	t <sub>rr</sub>	-	200	-	ns	V <sub>R</sub> =400V, I <sub>F</sub> =1.7A, d <i>i</i> <sub>F</sub> /d <i>t</i> =50A/μs
Reverse recovery charge	Qrr	-	0.7	-	μC	V <sub>R</sub> =400V, I <sub>F</sub> =1.7A, di <sub>F</sub> /d <i>t</i> =50A/μs
Peak reverse recovery current	I <sub>rrm</sub>	-	8	-	Α	V <sub>R</sub> =400V, I <sub>F</sub> =1.7A, di <sub>F</sub> /d <i>t</i> =50A/μs

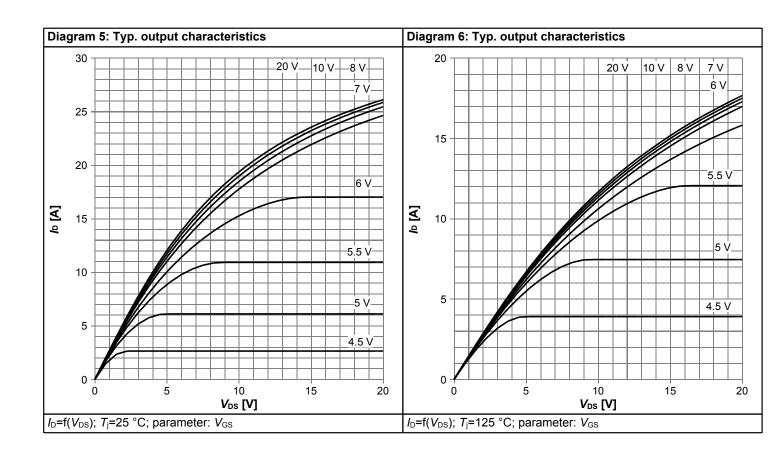


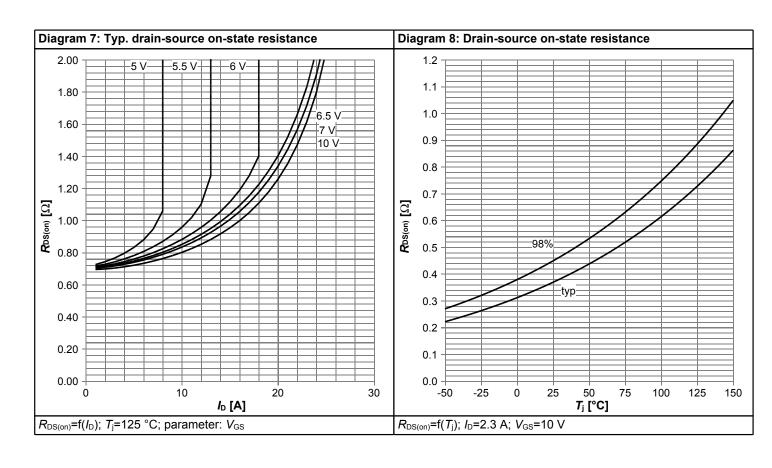
## 4 Electrical characteristics diagrams



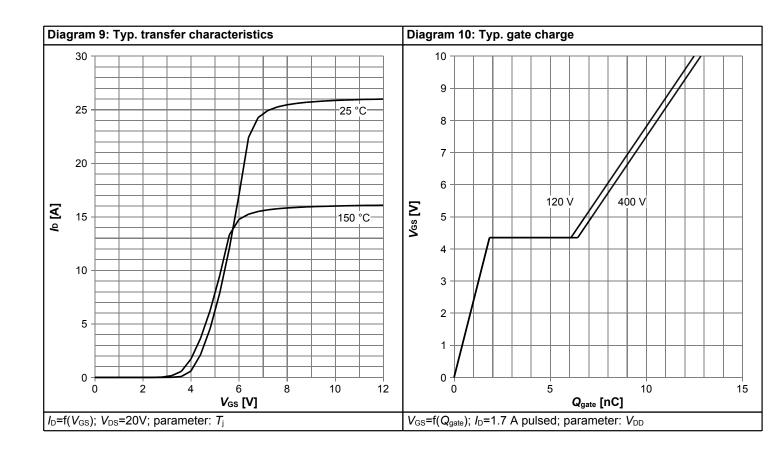


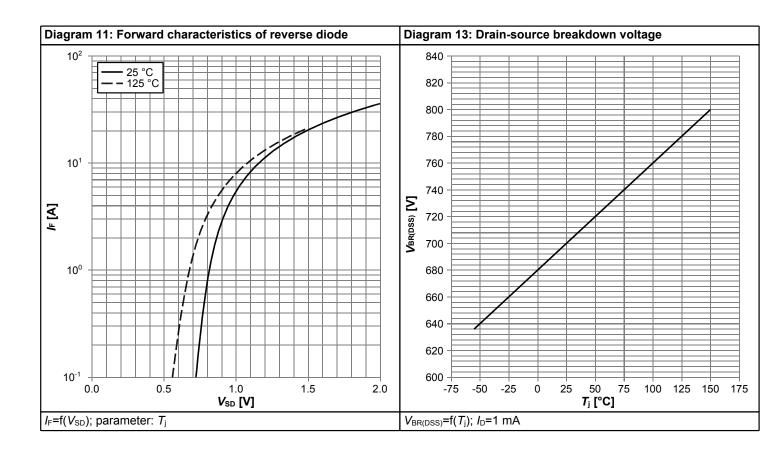




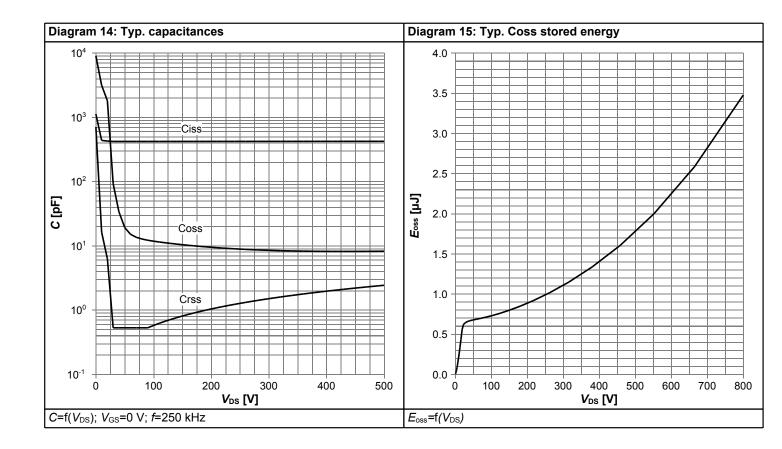














### 5 Test Circuits

**Table 8** Diode characteristics

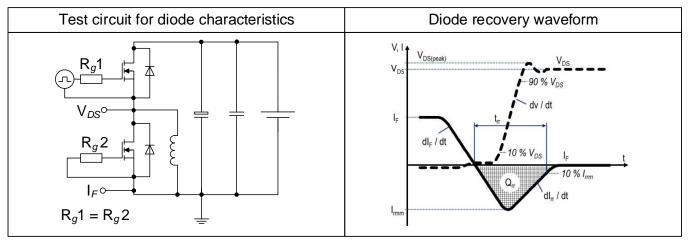
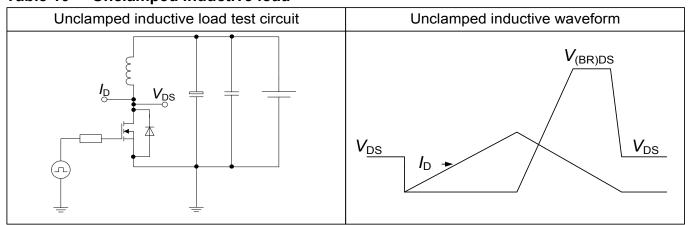


Table 9 Switching times



Table 10 Unclamped inductive load





## 6 Package Outlines

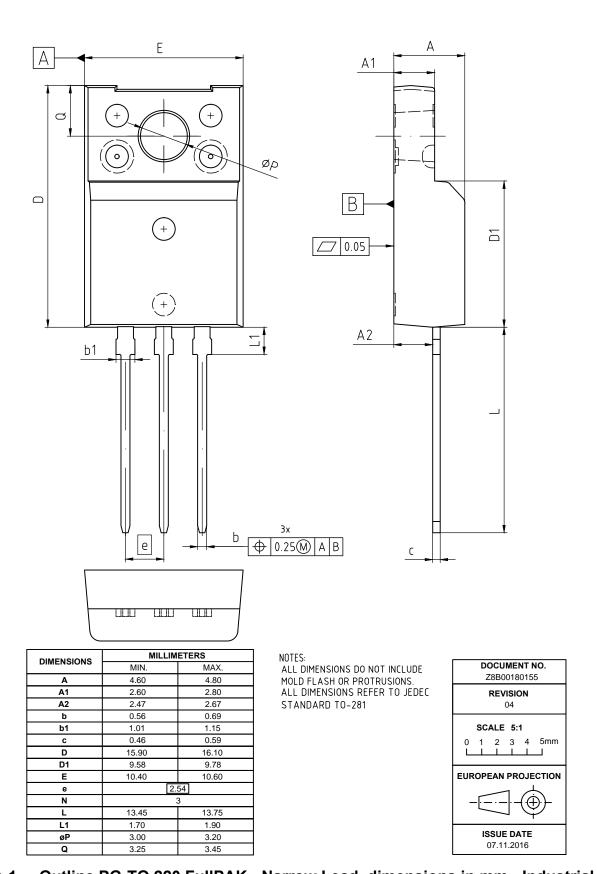


Figure 1 Outline PG-TO 220 FullPAK - Narrow Lead, dimensions in mm - Industrial Grade



## 7 Appendix A

### Table 11 Related Links

• IFX CoolMOS™ P7 Webpage: www.infineon.com

• IFX Design tools: www.infineon.com



#### **Revision History**

IPAN70R450P7S

Revision: 2018-02-13, Rev. 2.1

#### **Previous Revision**

Revision	Date	Subjects (major changes since last revision)
2.0	2017-09-15	Release of final version
2.1	2018-02-13	Corrected front page text

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